TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT Process)

# 2SC6026MFV

#### **General-Purpose Amplifier Applications**

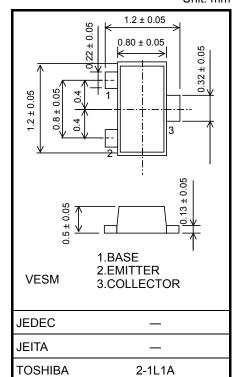
• High voltage and high current

: V<sub>CEO</sub> = 50 V, I<sub>C</sub> = 150 mA (max)

- Excellent h<sub>FE</sub> linearity : h<sub>FE</sub> (I<sub>C</sub> = 0.1 mA)/h<sub>FE</sub> (I<sub>C</sub> = 2 mA) = 0.95 (typ.)
- High h<sub>E</sub> : h<sub>E</sub> = 120 to 400
- Complementary to 2SA2154MFV

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Collector-base voltage	V <sub>CBO</sub>	60	V
Collector-emitter voltage	V <sub>CEO</sub>	50	V
Emitter-base voltage	V <sub>EBO</sub>	5	V
Collector current	Ι <sub>C</sub>	150	mA
Base current	Ι <sub>Β</sub>	30	mA
Collector power dissipation	PC	150*	mW
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	-55 to 150	°C



Weight: 1.5 mg (typ.)

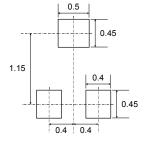
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in

the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

\* : Mounted on FR4 board (25.4 mm × 25.4 mm × 1.6mmt)

#### Mount Pad Dimensions (Reference)



Unit: mm

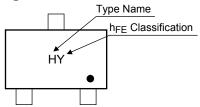
### Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = 60 V, I_E = 0$	_	_	0.1	μA
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = 5 \text{ V}, \text{ I}_{C} = 0$	_	_	0.1	μA
DC current gain	h <sub>FE</sub> (Note)	$V_{CE} = 6 V, I_C = 2 mA$	120		400	
Collector-emitter saturation voltage	V <sub>CE (sat)</sub>	$I_{C} = 100 \text{ mA}, I_{B} = 10 \text{ mA}$		0.15	0.25	V
Transition frequency	f <sub>T</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}$	60		_	MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, \text{ I}_{E} = 0, \text{ f} = 1 \text{ MHz}$		0.95	3	pF

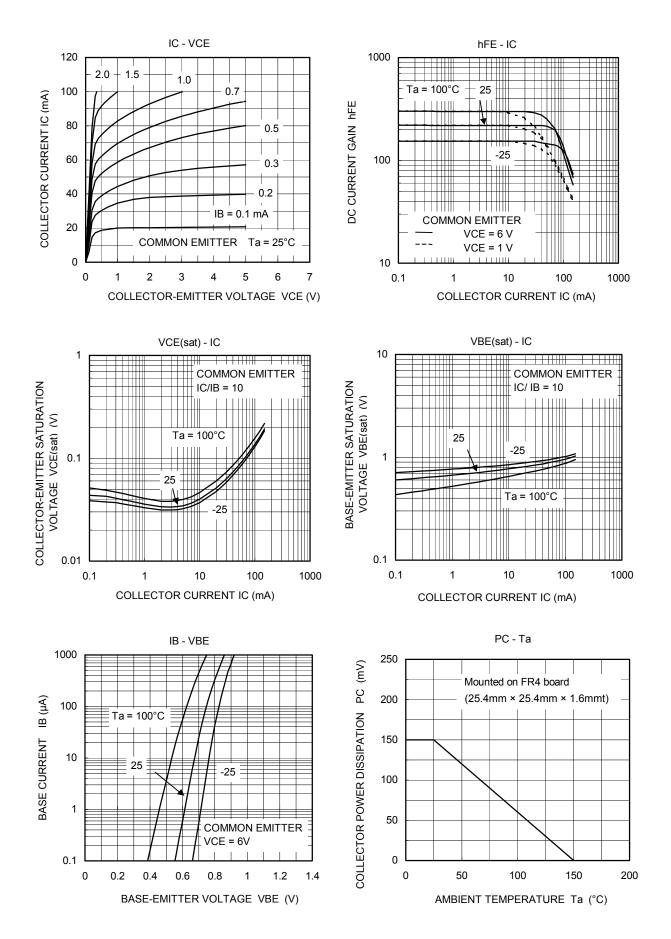
Note: hFE classification Y (Y): 120 to 240, GR (G): 200 to 400

() marking symbol

#### Marking



## **TOSHIBA**



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